

# SKKT 132 H4, SKKH 132 H4



**SEMIPACK® 2**

## Thyristor / Diode Modules

**SKKH 132 H4**

**SKKT 132 H4**

### Features

- Heat transfer through aluminium oxide ceramic isolated metal baseplate
- Hard soldered joints for high reliability
- UL recognized, file no. E 63 532

### Typical Applications\*

- DC motor control (e. g. for machine tools)
- Temperature control (e. g. for ovens, chemical processes)
- Professional light dimming (studios, theaters)

1) See the assembly instructions

|                |                         |  |                 |
|----------------|-------------------------|--|-----------------|
| $V_{RSM}$<br>V | $V_{RRM}, V_{DRM}$<br>V | $I_{TRMS} = 220$ A (maximum value for continuous operation)<br>$I_{TAV} = 132$ A (sin. 180; $T_c = 84$ °C) |                 |
| 2100           | 2000                    | SKKT 132/20E H4  | SKKH 132/20E H4 |
| 2300           | 2200                    | SKKT 132/22E H4  | SKKH 132/22E H4 |

| Symbol           | Conditions  | Values                 | Units                                |
|------------------|---|------------------------|--------------------------------------|
| $I_{TAV}$        | sin. 180; $T_c = 85$ (100) °C;                                      | 128 (90)               | A                                    |
| $I_{TSM}$        | $T_{vj} = 25$ °C; 10 ms<br>$T_{vj} = 125$ °C; 10 ms                 | 4500<br>3800           | A<br>A                               |
| $i^2t$           | $T_{vj} = 25$ °C; 8,3 ... 10 ms<br>$T_{vj} = 125$ °C; 8,3 ... 10 ms | 100000<br>72000        | A <sup>2</sup> s<br>A <sup>2</sup> s |
| $V_T$            | $T_{vj} = 25$ °C; $I_T = 500$ A                                     | max. 1,8               | V                                    |
| $V_{T(TO)}$      | $T_{vj} = 125$ °C   | max. 1,1               | V                                    |
| $r_T$            | $T_{vj} = 125$ °C   | max. 2                 | mΩ                                   |
| $I_{DD}; I_{RD}$ | $T_{vj} = 125$ °C; $V_{RD} = V_{RRM}; V_{DD} = V_{DRM}$             | max. 60                | mA                                   |
| $t_{gd}$         | $T_{vj} = 25$ °C; $I_G = 1$ A; $di_G/dt = 1$ A/μs                   | 1                      | μs                                   |
| $t_{gr}$         | $V_D = 0,67 * V_{DRM}$  | 2                      | μs                                   |
| $(di/dt)_{cr}$   | $T_{vj} = 125$ °C   | max. 200               | A/μs                                 |
| $(dv/dt)_{cr}$   | $T_{vj} = 125$ °C   | max. 1000              | V/μs                                 |
| $t_q$            | $T_{vj} = 125$ °C   | 50 ... 150             | μs                                   |
| $I_H$            | $T_{vj} = 25$ °C; typ. / max.                                       | 150 / 400              | mA                                   |
| $I_L$            | $T_{vj} = 25$ °C; $R_G = 33$ Ω; typ. / max.                         | 300 / 1000             | mA                                   |
| $V_{GT}$         | $T_{vj} = 25$ °C; d.c.  | min. 2                 | V                                    |
| $I_{GT}$         | $T_{vj} = 25$ °C; d.c.  | min. 150               | mA                                   |
| $V_{GD}$         | $T_{vj} = 125$ °C; d.c.   | max. 0,25              | V                                    |
| $I_{GD}$         | $T_{vj} = 125$ °C; d.c.   | max. 10                | mA                                   |
| $R_{th(j-c)}$    | cont.; per thyristor / per module                                   | 0,17 / 0,085           | K/W                                  |
| $R_{th(j-c)}$    | sin. 180; per thyristor / per module                                | 0,18 / 0,09            | K/W                                  |
| $R_{th(j-c)}$    | rec. 120; per thyristor / per module                                | 0,2 / 0,1              | K/W                                  |
| $R_{th(c-s)}$    | per thyristor / per module  | 0,1 / 0,05             | K/W                                  |
| $T_{vj}$         |   | - 40 ... + 125         | °C                                   |
| $T_{stg}$        |   | - 40 ... + 125         | °C                                   |
| $V_{isol}$       | a. c. 50 Hz; r.m.s.; 1 s / 1 min.                                   | 4800 / 4000            | V~                                   |
| $M_s$            | to heatsink   | 5 ± 15 % <sup>1)</sup> | Nm                                   |
| $M_t$            | to terminal   | 5 ± 15 %               | Nm                                   |
| a                |   | 5 * 9,81               | m/s <sup>2</sup>                     |
| m                | approx.   | 175                    | g                                    |
| Case             | SKKT<br>SKKH  | A 21<br>A 22           |                                      |



SKKT

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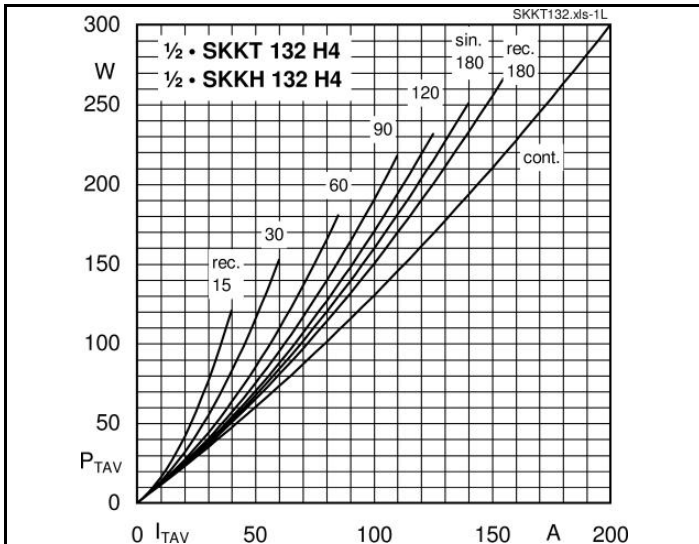


Fig. 1L Power dissipation per thyristor vs. on-state current

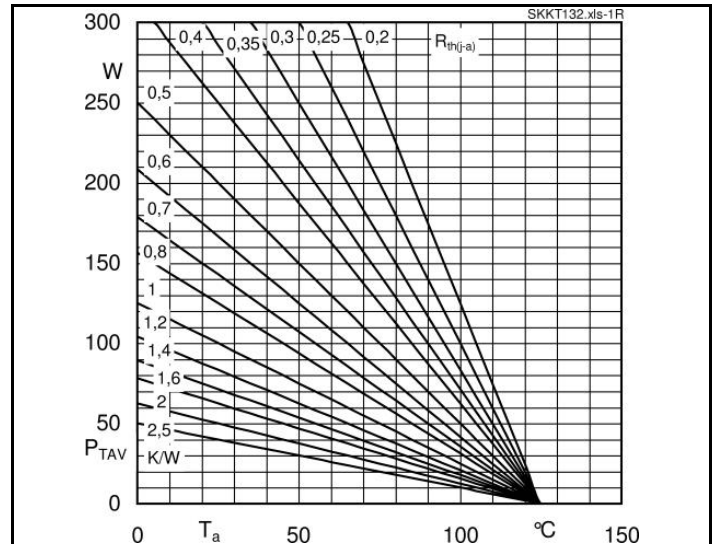


Fig. 1R Power dissipation per thyristor vs. ambient temp.

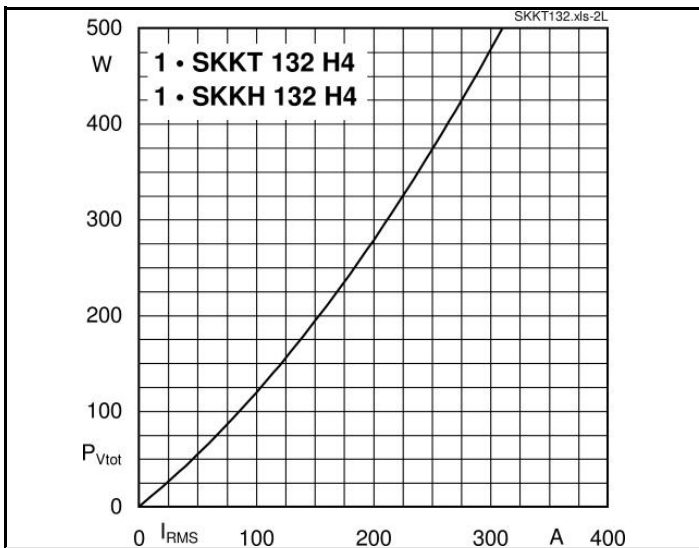


Fig. 2L Power dissipation per module vs. rms current

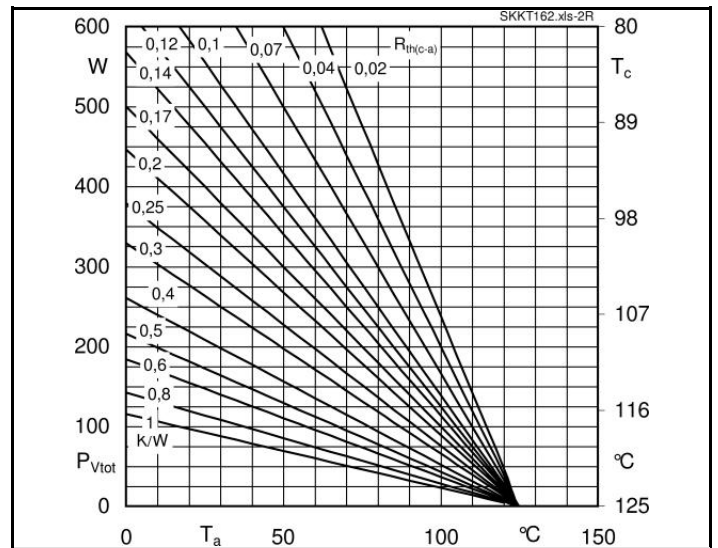


Fig. 2R Power dissipation per module vs. case temp.

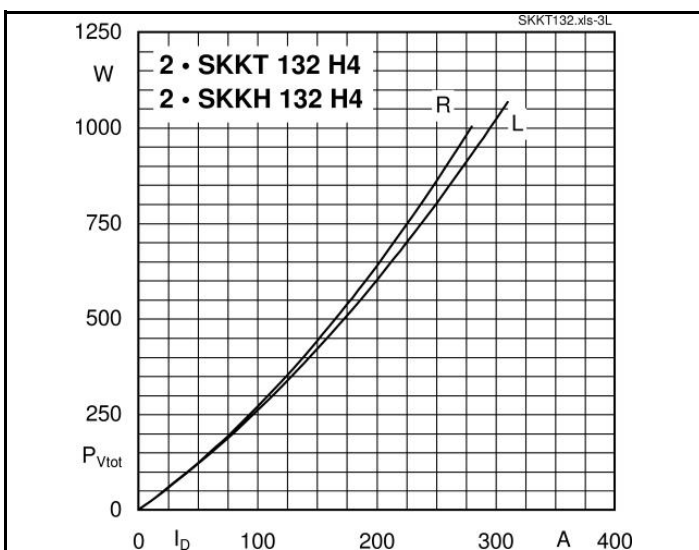


Fig. 3L Power dissipation of two modules vs. direct current

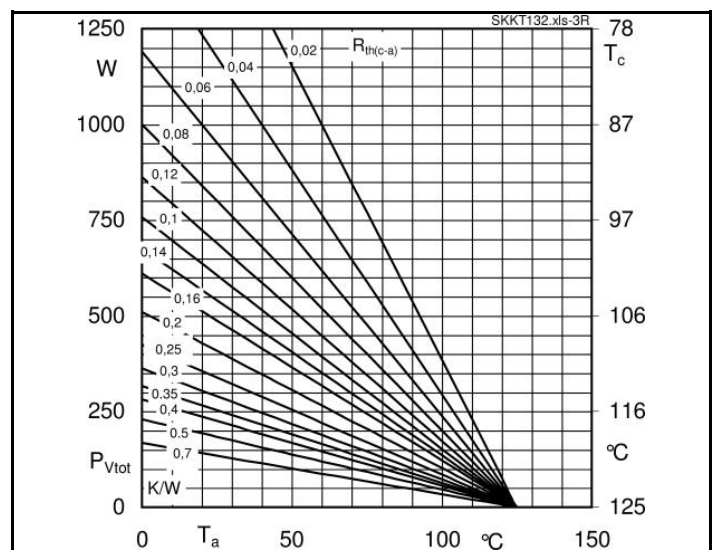
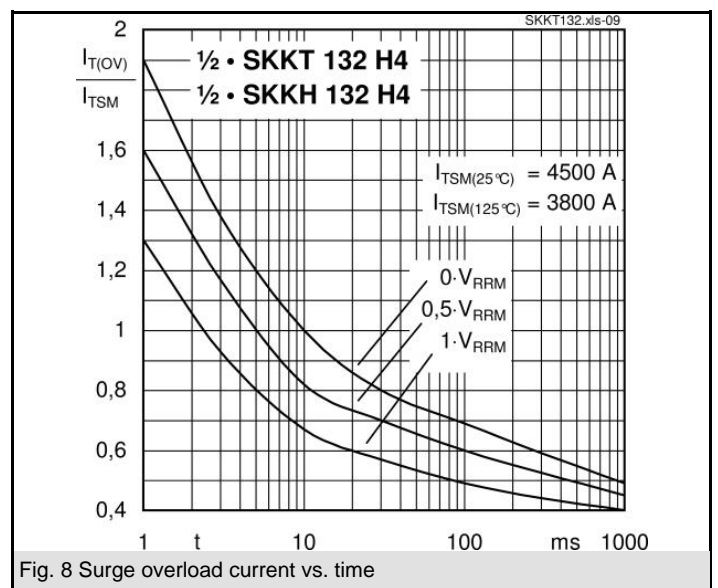
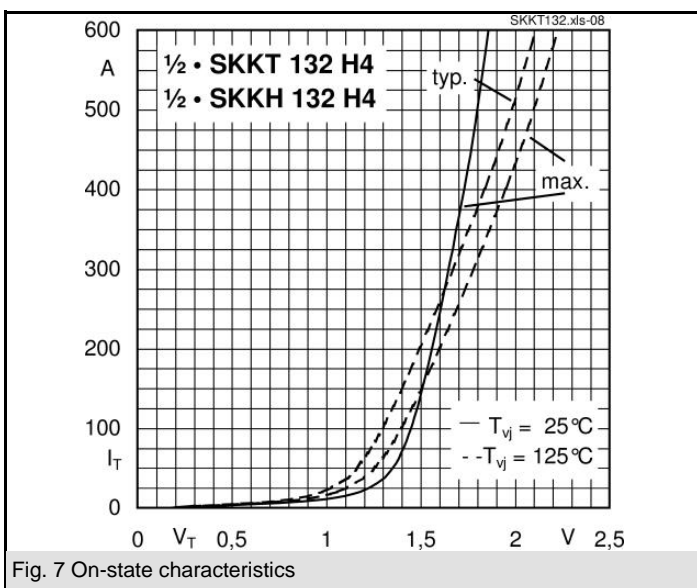
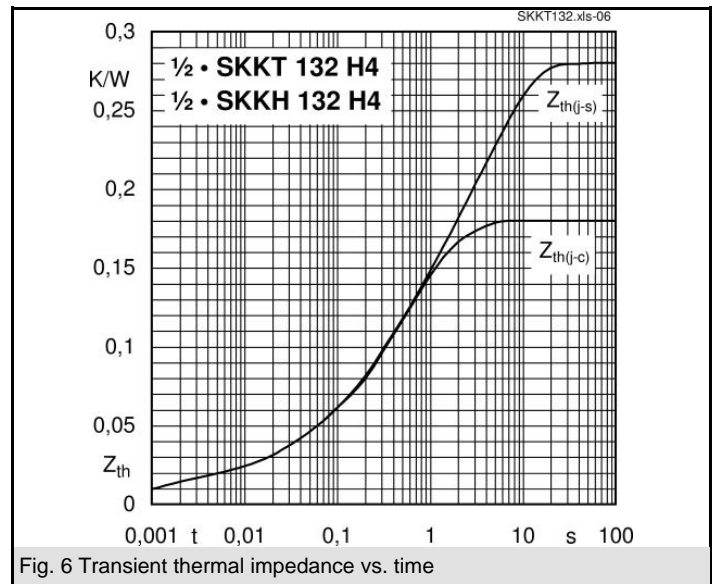
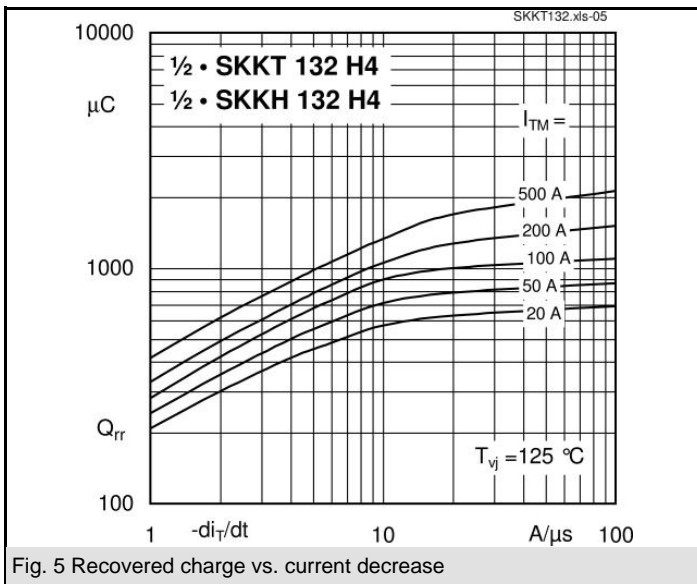
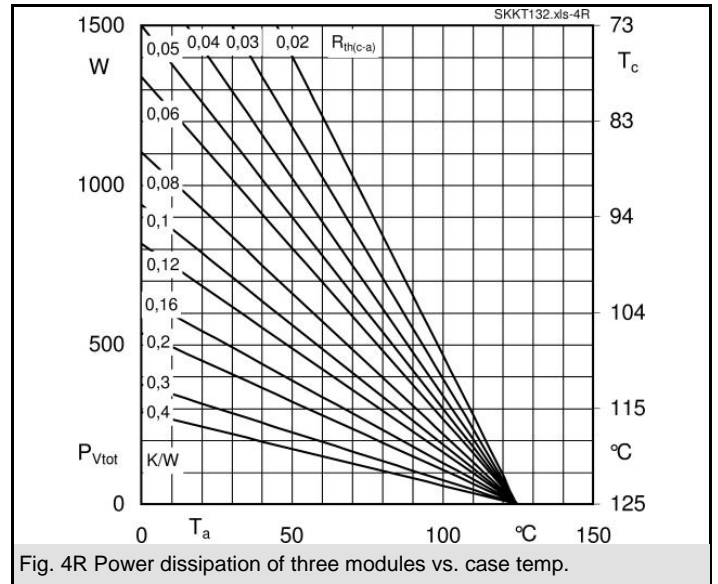
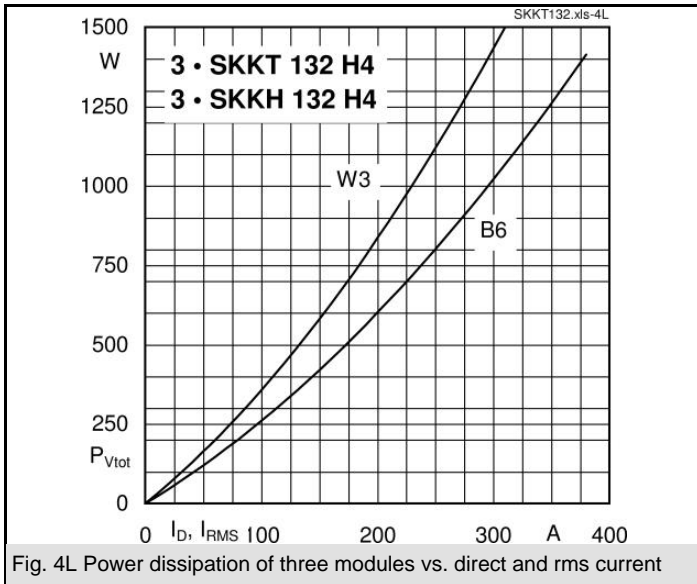
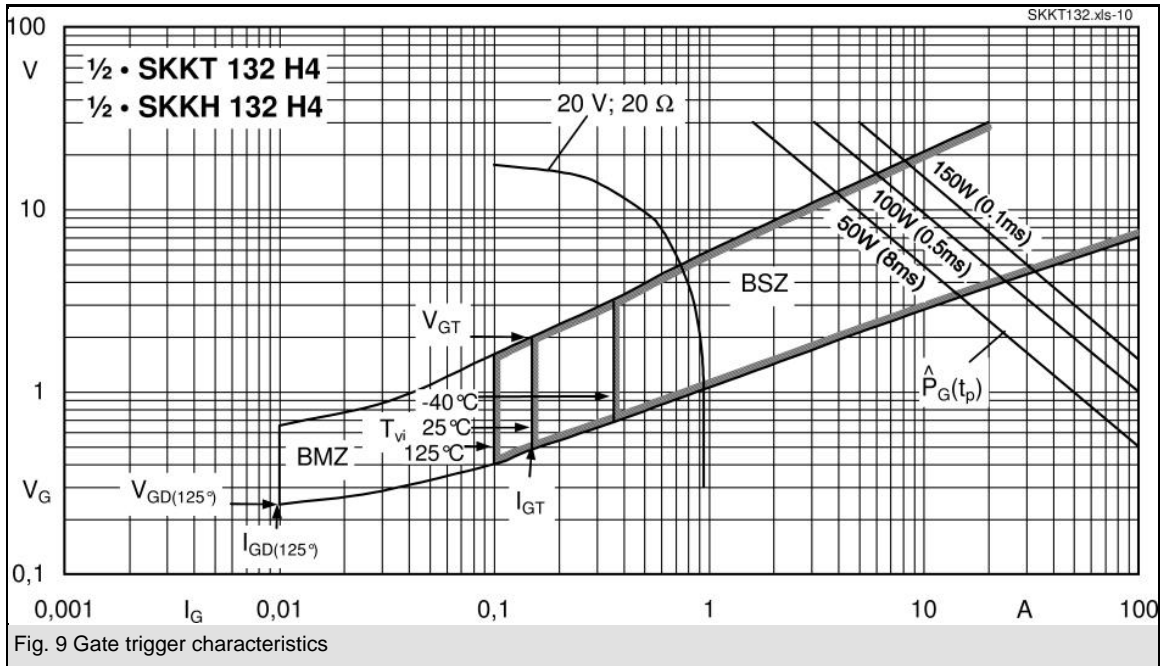


Fig. 3R Power dissipation of two modules vs. case temp.

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\* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON

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products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.